

**Amendments to the Claims:**

The following listing of claims will replace all prior versions, and listings, of claims in the application:

1. (Original) A stacking method of green sheet comprising the steps of;  
forming a support sheet with multilayer units by stacking the multilayer unit that comprises electrode layer and/or green sheet on a surface of the support sheet,  
forming a roll body by rolling up the support sheet with the multilayer unit, and  
stacking the multilayer units by unrolling the roll body, placing the support sheet with multilayer unit on a layer which the support sheet is to be placed, and separating the support sheet from the multilayer unit,  
wherein,  
a separation-facilitating surface treatment with a width equal to or greater than the width of the multilayer unit is formed on the back surface of the support sheet and an adhesive part where the separation-facilitating surface treatment is not provided is also formed.
2. (Original) The stacking method of green sheet as set forth in claim 1, wherein the adhesive part is successively or intermittently formed along a longitudinal direction of the support sheet on the back surface of said support sheet.
3. (Original) The stacking method of green sheet as set forth in claim 1, wherein a part where the separation-facilitating surface treatment is provided is successively formed along a longitudinal direction of the support sheet on the back surface of said support sheet.

4. (Currently Amended) The stacking method of green sheet as set forth in ~~any one of the claims 1 to 3~~ claim 1, wherein the adhesive parts are formed on the back surface of support sheet on one side or both sides of a width direction of said support sheet.

5. (Currently Amended) The stacking method of green sheet as set forth in ~~any one of the claims 1 to 3~~ claim 1, wherein on a surface of the support sheet, the separation-facilitating surface treatment, having a width equal to or greater than a width of the separation-facilitating surface treatment provided on the back surface of the support sheet.

6. (Currently Amended) The stacking method of green sheet as set forth in ~~any one of the claims 1 to 3~~ claim 1, wherein bond layer is stacked on a surface of the multilayer unit.

7. (Currently Amended) The stacking method of green sheet as set forth in ~~any one of the claims 1 to 3~~ claim 1, wherein an adhesive sheet is adhered to a back surface of support sheet, and by using said adhesive sheet, said support sheet is separated from the multilayer unit.

8. (Currently Amended) The stacking method of green sheet as set forth in ~~any one of the claims 1 to 3~~ claim 1, wherein the roll body is unrolled, the support sheet with multilayer unit is cut, the cut support sheet with multilayer unit is placed on a layer where it is to be stacked, the support sheet is separated from the multilayer unit, and the multilayer unit is stacked.

9. (Currently Amended) The stacking method of green sheet as set forth in ~~any one of claims 1 to 3~~ claim 1, wherein the multilayer unit comprises an electrode layer having a predetermined pattern and a blank pattern layer formed in a blank part between the electrode layers having a predetermined pattern.

10. (Currently Amended) A method of manufacturing a multilayer ceramic electronic device, comprising the steps of providing removing binder treatment and firing a multilayer body which is stacked by green sheet stacking method as set forth in ~~any one of the claims 1 to 3~~ claim 1.